

Ver.: 1.2

TFT LCD Specification

Model Name: TD019THEC1

Part No.: TD019THEC1

Customer Signature					
Date					

This technical specification is subjected to change without notice.



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Record of Revision

Rev	Issued Date	Description			
1.0	May. 27, 2008	New Release			
1.1	Jun. 26,2008	Add LED SPEC			
1.2	Jul. 21, 2008	Modified power consumption			



1. FEATURES

The 1.88" (4.7752 cm) LCD module is an active matrix color TFT LCD module. LTPS (Low Temperature Poly Silicon) TFT technology is used. Vertical and horizontal drivers are built on the panel.

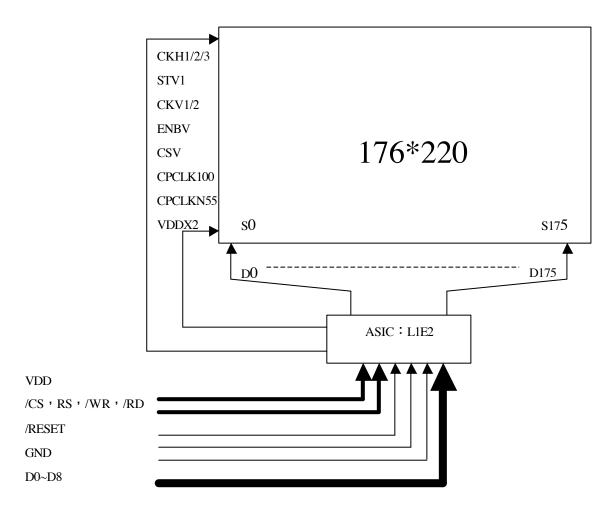
2. GENERAL SPECIFICATIONS

	Item	Description	Unit
1	Display Method	LTPS Active Matrix TFT	
2	Display Type	Transmissive	
3	Display Size (Diagonal)	1.88"	Inch
4	Resolution	176 x RGB x 220	
5	Pixel Pitch (HxV)	0.0565 x 0.1695	mm
6	Display Color	262K	
7	Glass Thickness(mm) Vendor	0.3 mm (NHT)	mm
8	Active Area (HxV)	29.83 x 37.29	mm
9	Viewing Area (HxV) 31.96 x 38.62		mm
10	Module Dimension (HxVxT) *	Dimension (HxVxT) * 36.3 x 50 x 2.05 (2D, 3D)	
11	Weight	8.3 +/- 0.5	g
12	Interface	9 bits CPU I/F	
13	Pin No	31	
14	Surface treatment 3H Hard coating		
15	Driver IC vendor	NTK NT39160	
16	Connector wonder	JST BM02B-ACHKS-GAN-TF	
10	Connector vendor	(Receiver connector)	
17	FPC vendor	旗勝	
18	Backlight LED Type vendor	凱鼎 2 pcs	
19	Operating Temperature Range	-20 ~ 70°C	
20	Storage Temperature Range	-30 ~ 80℃	
21	Operating Life	30000	Hr

^{*} Exclude FPCa and protrusions.



3. Block Diagram of Display







4. PIN Connection

Interface	Interfaces: CPU mode 8080 (Parallel)						
Connect	tor TYPE: N	Α					
Pin No	Pin Name	Pin Description					
1	VSS	Ground					
2	D0	Data 0					
3	D1	Data 1					
4	D2	Data 2					
5	D3	Data 3					
6	D4	Data 4					
7	D5	Data 5					
8	D6	Data 6					
9	D7	Data 7					
10	D8	Data 8					
11	/CS	Chip Select					
12	RS	Data/ Command (DC = 0: command; DC = 1: data)					
13	WR	Write Enable					
14	/RD	Read control signal					
15	TE	Tear effect signal output					
16	VSS	Ground					
17	LED+	LED Supply Voltage (LED1 & LED2 Anode)					
18	LED2-	LED2 Cathode					
19	LED1-	LED1 Cathode					
20	I_LED_G	Green LED control pin					
21	I_LED_O	Amber LED control pin					
22	I_LED_B	Blue LED control pin					
23	/RESET	Reset					
24	VSS	Ground					
25	VBAT	RGB LED power					
26	VDD	DC/DC Supply Voltage (2.5V~3.6V)					
27	VSS	Ground					
28	VSS	Ground					
29	EARN	Receiver pin					
30	EARP	Receiver pin					
31	VSS	Ground					



5. Absolute Maximum Ratings

VSS=0V

Parameter	Symbol	Rating	Unit
Power supply	VDD	-0.3 to VDDA+0.3	V

6. Typical Operation Conditions

VSS=0V, Ta=25°C

Parameter	Cymbol	Condition	Sp	Unit		
Parameter	Symbol Condition		Min	Min Typ		Ollit
Power Supply Voltage	VDD	Operating Voltage	2.5	3.0	3.6	V
Logic High level input voltage	VIH		0.8VDDI		VDDI	V
Logic Low level input voltage	VIL		VSS		0.2VDDI	V
Logic High level output voltage	VOH	IOUT= -1mA	0.8VDDI		VDDI	V
Logic Low level output voltage	VOL	IOUT=1mA	VSS		0.2VDDI	V
Logio High lovel input ourrent	IIH	Except D[70]			10	Α
Logic High level input current	IIHD	D[70]			10	uA
Logic Low lovel input current	IIL	Except D[70]	-10			uA
Logic Low level input current	IILD	D[70]	-10			uA

7. Power Consumption

Normal mode:

Full Screen 176x220 262K colors at 70Hz frame frequency

Input Voltage (VDD=2.8 V, VDDI=1.8/2.8 V)

Display Pattern: Color Bar Operating Temp.: 25°C



Partial mode:

Partial Screen 176x32 8 colors at 70Hz frame frequency

Input Voltage (VDD=2.8 V, VDDI=1.8/2.8 V)

Display Pattern: Partial 8 Color Bar

Operating Temp.: 25°C



Standby mode:

Display Off; Oscillator off; internal regulator



TD019THEC1

Item	Characteristics	Symbol	Min	Typical	Max	Unit
1	1 Power consumption in Normal Mode			5.35	6.89	mW
2	2 VDD Current consumption in Normal Mode			1.91	2.46	mA
3	Power consumption in Partial Mode	P _{Partial}		1.29	1.6	mW
4	VDD Current consumption in Normal Mode	I VDD-Partial		0.46	0.55	mA
5	Power consumption in Standby Mode	P _{STBY}			90	uW
6	VDD Current consumption in Standby Mode	I _{VDD-STDBY}			30	uA

8. Backlight driving condition

Ta=25°C

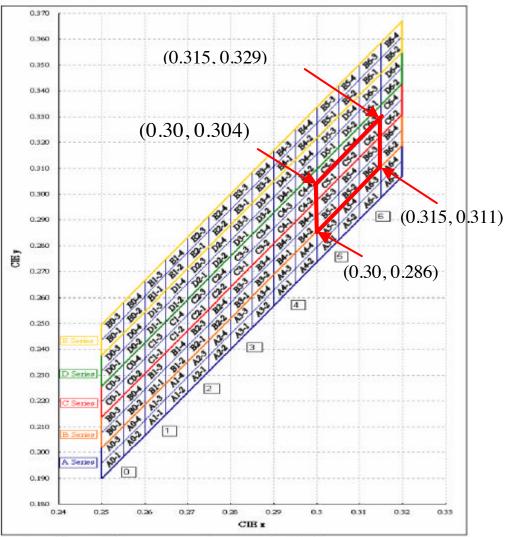
Parameter	Symbol	Min	Typical	Max	Unit	Remark
LED Voltage	V_L	3.0	3.2	3.3	٧	
LED Current (V _{L=} 3.3V)	l.		20		mA	Tolerance with+/-5%
Power Consumption	W_{L}		128		mW	2 LEDs

8.1 LED SPEC (For LCM Module use only)

LED Part Name	SPEC					
Light House-LT-15056C1 WD-CA1-0A	Luminous: Rank V2 (1520-1600 mcd) at 20 mA/ Ta= 25°C. Rank V3(1600~1690 mcd) at 20 mA/ Ta= 25°C. Color Ranks: C5-1, C5-2, C6-1, B5-3, B5-4, B6-3, B5-1, B5-2, B6-1 rank at 20 mA/ Ta= 25°C Volt Rank(Vf): 3.0V~3.1V \ 3.1V~3.2V \ 3.2V~3.3V \ 3.3V~3.4V \					
AOT-0603GS31A-Z0-N-3 LED_GREEN	3.4V~3.5V \ 3.5V~3.6V at 20 mA/ Ta= 25°C, Wavelength :520~530 Brightness:60~110mcd					
AOT-0603BL31A-N0-N-3 SMT Blue Color LED_Blue	Wavelength :465~475 Brightness:9~23mcd					
AOT-0603AM31A-N0-N-3 SMD LED:Amber color	Wavelength :600~610 Brightness:24~60mcd					







Color Coordinates Measurement allowance is \pm 0.01.

	WO	(%) 	WIN 5-2		79T)	Ch-:
	7	Ä	7	`*	7	`4
L	0.7	0,308	000	0.96	8.33	0.314
		机基体	0.96	0:312	0.01	0.330
[11.305 205.11	0.313	W.FE	0.500	93305	(1.2.23)
	0.85	0.8%	U.3:	0.014	0015	112

W.(5	#1(X)*<->		\$\$TX(5-4		W1X 9-3	
\ \	'n	7	¥		7	,**
0.3	0.94	0,903	0.310	IL	a.n	0.32a
ųį:		0.98	0 slx		0.31	0.8%
ULS03	0.315	W.7 E	0.536		0116	0.065
0.85	0.02	11.30	Wildle		0.545	11(2)

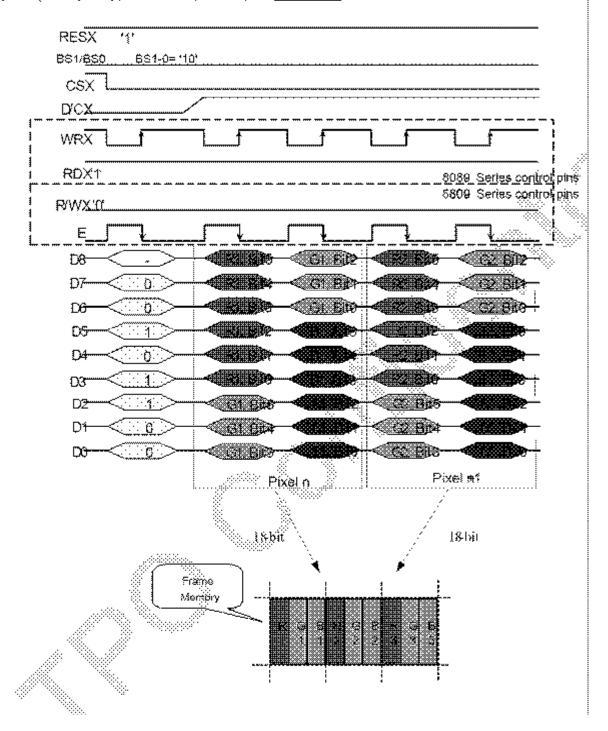
WYS	VT NEW - 1 WT (185-)		N5-3	75,7	11: 1:-:
ä	::	Σ	V.	Ν	¥
2.1	0.297	0.903	0.240	3,31	0,200
:1,3	4,342	0.985	0,500	0.84	6,866
11,305	0,9%)	6.30	6,96	0.345	6,317
0.805	9.294	11.35	00.00	0.545	11.311



9. AC Timing Characteristics

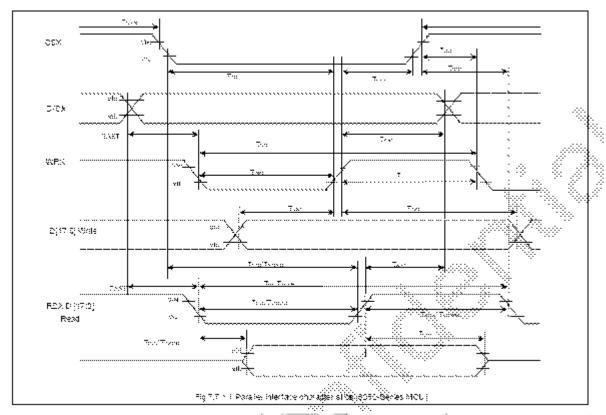
Write 9-bit data for RGB 6-6-6-bits input (262k-color)_

There are 2 pixels (6 sub-pixels) per 4-transfer, 18-bits/pixel._3AH="06h"





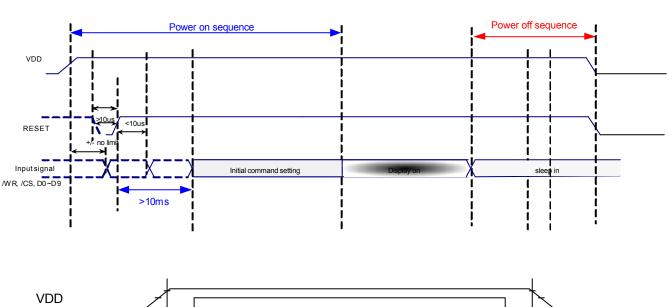
CPU Interface 8080 Mode

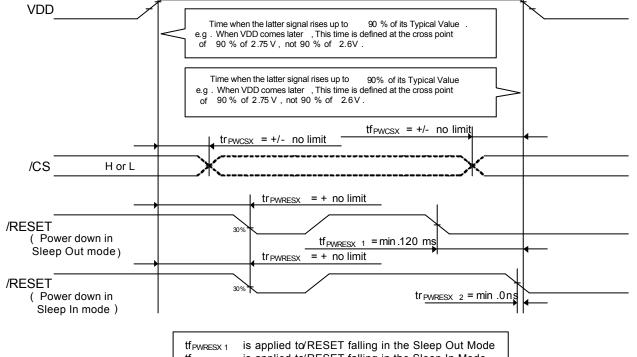


Signal	Symbol	Parameter	MIN	MAX	Unit	Description	
D/CX	tAST	Address setup time	10	197	ns		
DICA	tAHT	Address hold time (Write/Read)	10	100	ns	-	
	tCHW	Chip select "H"pulse width	0		ns		
	tCS	Chip select setup time (Write)	35		ns		
CSX	tRCS	Chip select setup time (Read ID)	45		ns		
COV	tRCSFM	Chip select setup time (Read FM)	355	(C)	ns		
	tCSF	Chip select wait time (Write/Read)	10		ns		
	tCSH	Chip select hold time	10		ns		
WRX	tWC	Write cycle	80	8	ns		
	tWRH	Control pulse "H" duration	35	e e	ns		
	tWRL	Control pulse "L" duration	35		ns	Î	
	tRC	Read cycle (ID)	160	37	ns	When read ID data	
RDX (ID)	tRDH	Control pulse "H" duration (ID)	90	10 0	ns		
381 180	tRDL	Control pulse "L" duration (ID)	45		ns		
	tRCFM	Read cycle (FM)	450		ns	When read from	
RDX (FM)	tRDHFM	Control pulse "H" duration (FM)	90		ns	frame memory	
	tRDLFM	Control pulse "L" duration (FM)	355	100	ns	marile memory	
D[17:0]	tDST	Data setup time	10		ns	F	
	tDHT	Data hold time	10		ns	For maximum	
	tRAT	Read access time (ID)		40	ns	CL=30pF For minimum	
	tRATFM	Read access time (FM)		340	ns	CL=8pF	
	tODH	Output disable time	20	80	ns	OL-opi	



10. Display Power on/down Sequence

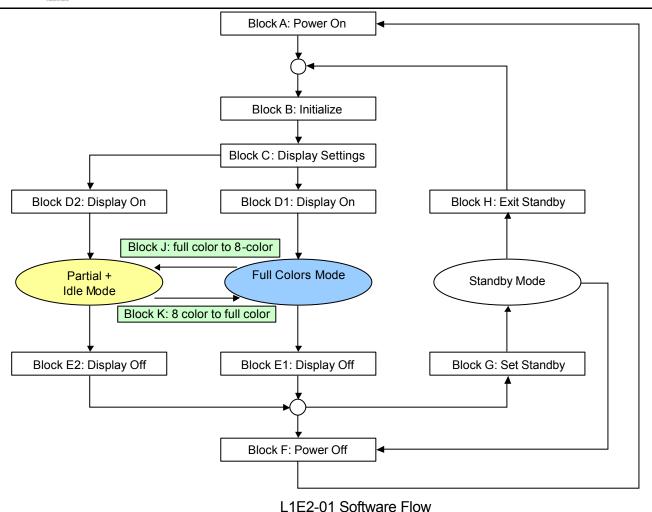




tf_{PWRESX 2} is applied to/RESET falling in the Sleep In Mode

Note: Unless otherwise specified, timings herein show cross point at 50% of signal/power level





Power on Sequence:

Block A: Power On

Step	Register	Setting	Operation			
1		HW reset				
2			Delay 120ms			
3	11h	11h - Sleep out				
4	CEh	0x0F 0x01	Close the VDC voltage for Panel control power			
5		Delay 120ms				
6			Initialize			



Block B: Initialize setting

Step	Register	Para	meter Setting	Operation
3	AAh			GAMMA Separate off
4	0xC0	1 st	0x04	GAMMA reference voltage setting
5	0xE6	1 st	0x01	GAMMA setting enable
		1 st	0x1B	
		2 nd	0x17	
		3 rd	0x0A	
		4 th	0x0B	
		5 th	0x07	
		6 th	0x09	
		7 th	0x09	
		8 th	0x0D	GAMMA 2.4
6	0xE2	9 th	0x09	Positive setting
		10 th	0x06	r ositive setting
		11 th	0x00	
		12 th	0x00	
		13 th	0x03	
		14 th	0x02	
		15 th	0x0C	
		16 th	0x2B	
		17 th	0x38	
7	0xE3	1 st	0x18	GAMMA 2.4
		2 nd	0x13	Negative setting
		3 rd	0x14	
		4 th	0x18	
		5 th	0x15	
		6 th	0x16	
		7 th	0x12	
		8 th	0x0D	
		9 th	0x05	
		10 th	0x1A	
		11 th	0x23	
		12 th	0x1F	
		13 th	0x2B	
		14 th	0x28	



		15 th	0x20	
		16 th	0x43	
		17 th	0x0C	
8	35h		0X00 or 0X01	TE mode 1,2 select (optional)

Block C: Display Settings (176X220)

Step	Register	Setting	Operation
1	13h	-	Normal display on
2	2Ah	MV=0(0x00~0XAF) MV=1(0x00~0XDB)	Column address set (Parameter range: 0 <xs[15:0]< (parameter="" ,="" 0<xs[15:0]<="" <="" mv="1" range:="" th="" xe[15:0]<175)="" xe[15:0]<219)=""></xs[15:0]<>
4	2Bh	MV=0(0x00~0XDB) MV=1 (0x00~0XAF)	Row address set (Parameter range: 0 <ys[15:0]< (parameter="" ,="" 0<ys[15:0]<="" <="" mv="1" range:="" th="" ye[15:0]<175)="" ye[15:0]<219)=""></ys[15:0]<>
5	30h	0x00~0XDB	Partial area (PSL,PEL)
6	33h	TFA: 0x00~0XDC VSA: 0x00~0XDC BFA: 0x00~0XDC	Scroll area (TFA+VSA+BFA=220)
7	37h	0x00~0XDB	Vertical scroll start address of RAM
8	3Ah	0x55	Interface pixel format (base application)

Block D1: Display On

Step	Register	Setting	Operation				
1	29h	-	Display on				
2		Full Color Mode Display On					

Block D2: Set Idle and partial mode

Step	Register	Setting	Operation	
1	39h	1	Idle mode on	
2	12h	1	Partial mode on	
3	29h	-	Display on	
4	8 Color Mode Display On (Idle Mode)			



Block E1,E2: Display Off

Step	Register	Setting	Operation			
1	28h	-	Display off			
	Display off mode					

Block G: Set Standby

Step	Register	Setting	Operation		
1	10h	-	Sleep in		
	Standby mode				

Block H: Exit Standby

Step	Register	Setting	Operation				
1	11h	-	Sleep out				
2		Delay 120ms					
	Normal mode						

Block J: Full color to 8-color mode

Step	Register	Setting	Operation			
1	12h	-	Partial mode on			
2	39h	-	Idle mode on			
	Partial + 8 Color Mode (Idle Mode)					

Block K: 8-colors to Full color mode

Step	Register	Setting	Operation					
1	38h	-	Idle mode off					
2	13h	-	Normal display on					
	Full Color Mode							



Power down Sequence:

Block F: Power Off

Step	Register	Setting	Operation						
1	10h	-	Sleep in						
2		Delay (120msec)							
3		RES = L							
4	VDD OFF								
5			VDDI OFF						



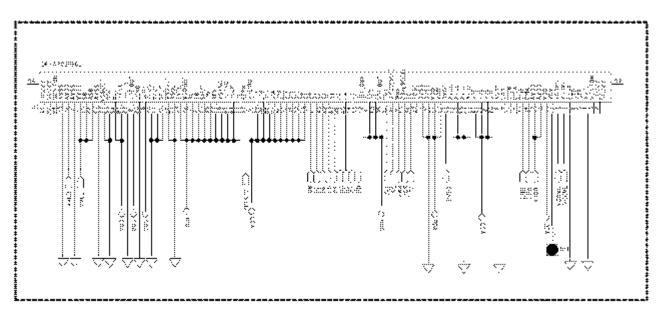
11. FPC

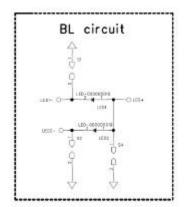
a. BOM

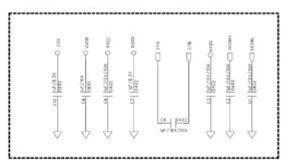
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				Conductine Guidate 2/2016/7-4442-01 SLI	CORD Becom 2007 4 254 351 4cm BMB	1968_3.77vin_139us	SWD LED Mother roles; JRV-415 1 8-0 297 Wanningt 500-510 Brighteno 34-90 and	SMT that Color LED_DEG_30—465_ACT: 1893-B110-B_Bise (A65-ATTemp) Washingto 465—475 Brightman 5-25mcd	LED_08EEN 2 6-3 (V_9608)1 6*03*0.4mm) Wanningth 500-510 Englissen:50-110mcd	10.00	MULTILAMER CHIP VARIETOR (5 5%.					から100 mg か か か か で で で で 100 100 mg で で で 100 100 mg か で 100 100 mg で 100 100 mg で 100 mg で 100 mg か 100 mg で	197	Ass	AII	CSF	Terroripides Billie	TPO Optoelectronics Cosp.
	注意: 此為这本語的項目,非常 件,接工程和注意,從知會打件期									04-D11動物的相關模式 Vantor - 平可提供。	D. 物 DOTEM						XIII	Odiv	XSE	XII	H.M.	
		74		ARTH	NET.	LBritish 274370 3 Fidesgler		んのできる場合		1900	A FEERige	ATTO MERCINE	SALEC Tages	San Santa	SETTING STATES		APOSpoots Reference SPET Tube Votes State State	a POSConnes Bulg Dana S-87% Topo Yoku Mallana Yupu	ATRISports Ruly Street ##2 Top Yole Matrix State	ARABANAN Kolo Stean PPPE Topin Vales Militas Vapos	***	
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b. Schematics

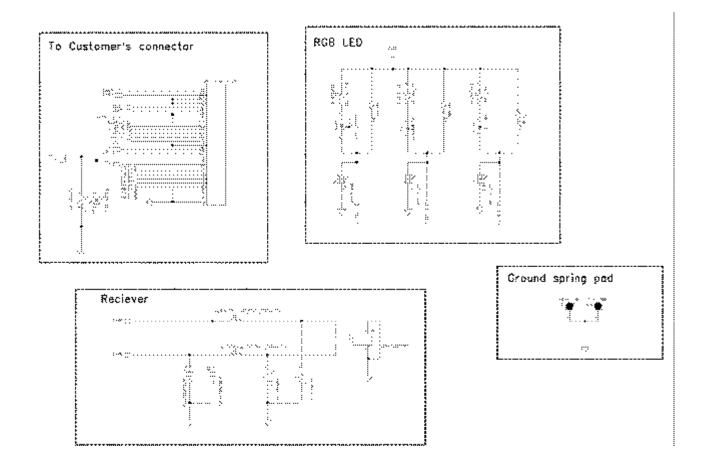




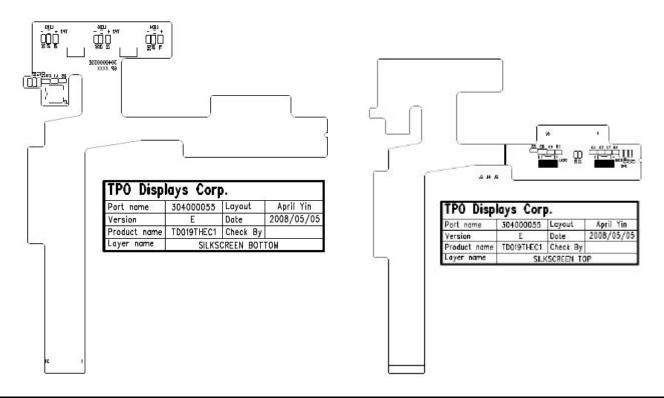








c. Components Location







12. ESD test

	Test Item	SPEC	Note
Module	 HBM R=1.5k ohm ,C=100pF	+/- 5.0kV	VDD, VDDI ,Reset
	HBM (R=1.5k ohm ,C=100pF)	≧+/-2.5kV	
ASIC	MM (R=0k ohm ,C=200pF)		Refer to ESD report of ASIC Vendor
	Latch Up	≧200mA	



13. OPTICAL CHARACTERISTICS

13.1 Optical Specification (Back Light On, LED current = 20mA)

Ta=25°C

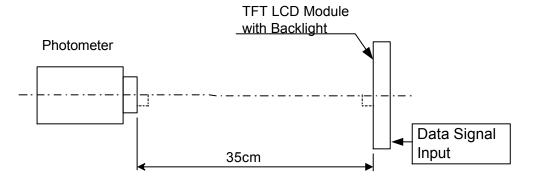
	To at the sec	SPEC					
	Test Item	Min	Тур	Max			
1	CR	200	350				
2	CD	High T(60deg)		220	380		
	CR	Low T(-20deg)		140	250		
		Theta=45, phi = 0		15	25		
3	Viewing Angle	Theta=45, phi = 90		5	10		
	(Iso-CR plot)	Theta=45, phi = 180		0.5	2		
		Theta=45, phi = 270		5	10		
		CR>10, phi = 0		40	50		
4	Viewing Direction	CR>10, phi = 90		35	45		
4	Viewing Direction	CR>10, phi = 180		10	20		
		CR>10, phi = 270		35	45		
5	Brightness	•		220	260		
6	Brightness uniformity (%)			80	-		
7	Flicker (dB)					-30	
8	Cross talk (%)					6	
9	Gamma-12GS (plot)				2.2		
		White	Х	0.266	0.316	0.366	
		vvriite	у	0.289	0.339	0.389	
		Red	Х	0.582	0.632	0.682	
10	Color Chromaticity	Reu	у	0.296	0.346	0.396	
10	(defined by DMS-900 spectrum meter)	Graan	Х	0.253	0.303	0.353	
	meter)	Green	у	0.546	0.596	0.646	
		Dive	Х	0.086	0.136	0.186	
		Blue	У	0.045	0.095	0.145	
11	NTSC	55	65				
12	Response Time (ms)			35	45		
12	Posponso Timo (ms)	High T(60deg)			20		
13	Response Time (ms)	Low T(-20deg)			400		
14	MSA (Gauge R&R)	Luminance			30%		



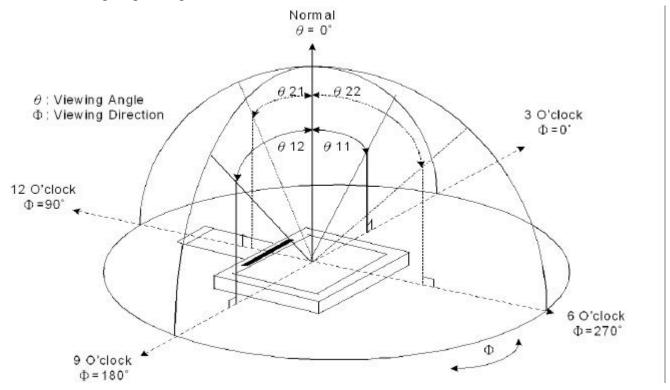
		CR			
		Uniformity			
		Flicker			
15	Cpk (Luminance, CR , Uniformity, F	>1.33			
16	Polarizing Angle (absorption axi	UP = 135 deg/Down =45 deg			
17	BEF Angle		45 deg.		

13.2 Basic Measure Condition

- (1) Ambient Temperature: Ta=25°C
- (2) Testing Point: Measure in the display center point and the test angle T=0°
- (3) Measuring System
 - a. Measure System A



13.2.1: Viewing angle diagram:

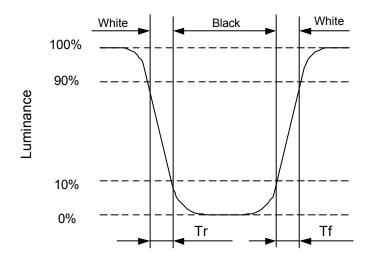




13.2.2: Contrast Ratio as Backlight On: (Measure System A)

Contrast ratio is measured in optimum common electrode voltage. The signal amplitude

13.2.3: Definition of response time: (Measure System A)





13.2.4: Luminance: (Measure System A)

Test Point: Display Center LED Current I_F = 20 mA

13.2.5: Chromaticity: The same test condition as 13.2.4

13.2.6: Contrast Ratio as Backlight Off (Measure System A)

Contrast ratio is measured in optimum common electrode voltage. The signal amplitude

13.2.7: White chromaticity as back light off (Measure System A)

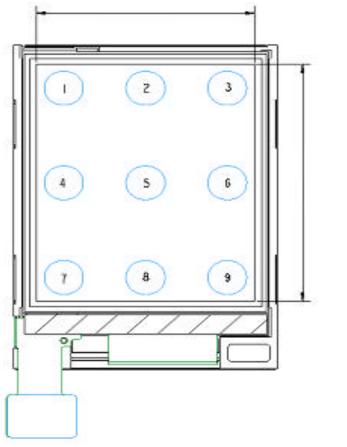
13.2.8: Reflectance (Measure System A)

Reflection ratio(R) =
$$\frac{\text{Light detected level of refection by the LCD module}}{\text{Light detected level of refection by the standard white}}$$

13.2.9: Definition of uniformity: Light on backlight 5 minutes before test.

The definition of 3 columns X 3 rows test points:

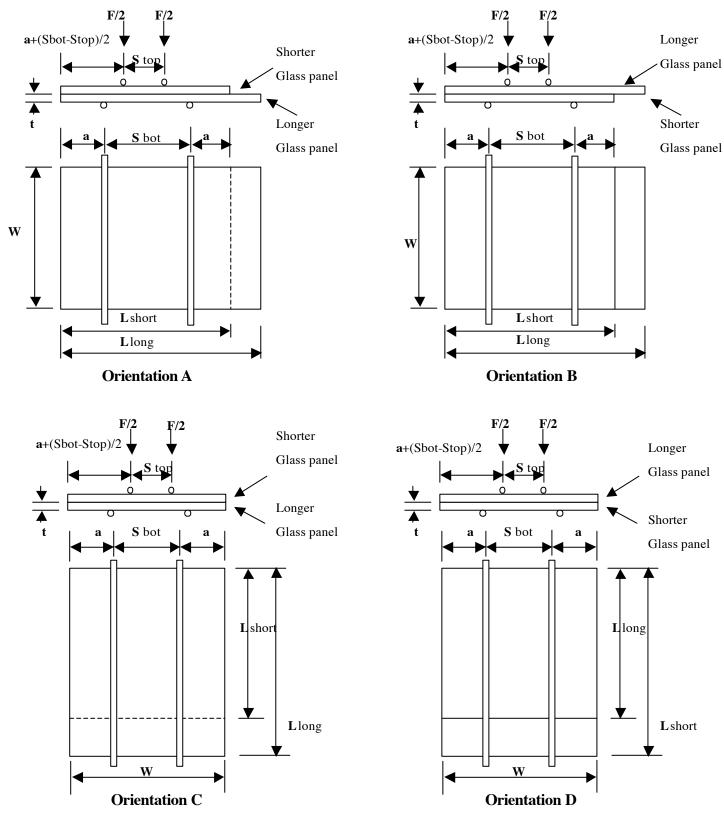
29.83 AA





14. GLASS QUALITY REQUIREMENT

14.1 The LCD glass strength (failure load) will be defined at a single 90% survival rate value. The B10 strain shall be meet 0.15% on both orientation A & orientation B. LCD glass strength test setup as below attached drawing.



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14.2 The Anisotropic Conductive Film (ACF) joint between glass and flex must have minimum of 1 lb/in peel strength.

15. RELIABILITY

No	Test Item	Condition		
1	High Temperature Operation	Ta = +70°C, 240hrs		
2	High Temperature & High Humidity Operation	Ta = +60°C, 90% RH, 88hrs		
3	Low Temperature Operation	Ta = -30°C, 240hrs		
4	High Temperature Storage (non-operation)	Ta = +85°C, 240hrs		
5	Low Temperature Storage (non-operation)	Ta = -40°C, 240hrs		
6	Heat Sheek (non eneration)	-40°C ← → 85°C, 27cycles		
6	Heat Shock (non-operation)	(30min / 30min)		
7	Electrostatic Discharge	±250V, C=200pF, R=0Ω;		
′	(Machine mode; non-operation)	Once for each terminal		
8	Electrostatic Discharge	±2.5KV, C=100pF, R=1.5KΩ;		
0	(Human body mode; non-operation)	Once for each terminal		
		НВМ		
9	Electrostatic Discharge (Operation)	±5kV, (VCC, VCI, Reset)		
		C=100pF, R=1.5KΩ;		
		Height: 80cm		
10	Shock Test (Package state)	1 Corner, 3edges, 6 surfaces		
		(Once for each direction)		

Note: Ta: Ambient Temperature



16. HANDLING CAUTIONS

A. ESD (Electrical Static Discharge) Strategy

ESD will cause serious damage of the panel, ESD strategy is very important in handling. Following items are the recommended ESD strategy

- i. In handling LCD panel, please wear non-charged material gloves. Connect the wrist conduction ring to the earth and the conducting shoes to the earth are necessary.
- ii. The machine and working table for the panel should have ESD protection strategy.
- iii. In handling the panel, using ionized air to decrease the charge in the environment is necessary.
- iv. In the process of assembly the module, shield case should connect to the ground.

B. Environment

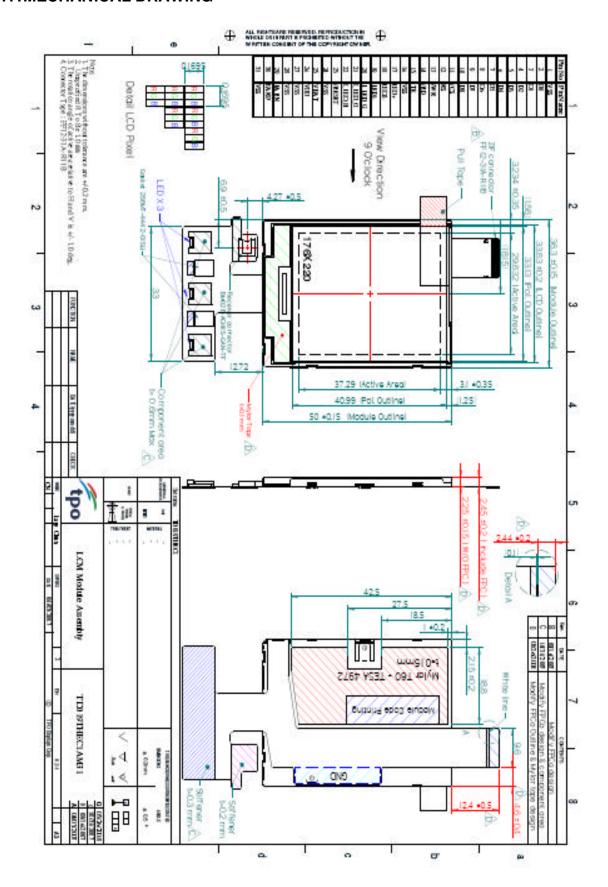
- v. Working environment of the panel should be in the clean room.
- vi. The front polarizer is easy damaged. Handle it carefully and do not scratch it by sharp material.
- vii. Panel has polarizer protective film in the surface. Please remove the protection film of polarizer slowly with ionized air to prevent the electrostatic discharge.

C. Others

- viii. Turn off the power supply before connecting and disconnecting signal input cable.
- ix. Water drop on the surface or condensation as panel power on will corrode panel electrode.
- x. As the packing bag open, watch out the environment of the panel storage. High temperature and high humidity environment is prohibited.
- xi. When the TFT LCD module is broken, please watch out whether liquid crystal leaks out or not. If your hand touches liquid crystal, wash your hand cleanly by water and soap as soon as possible.

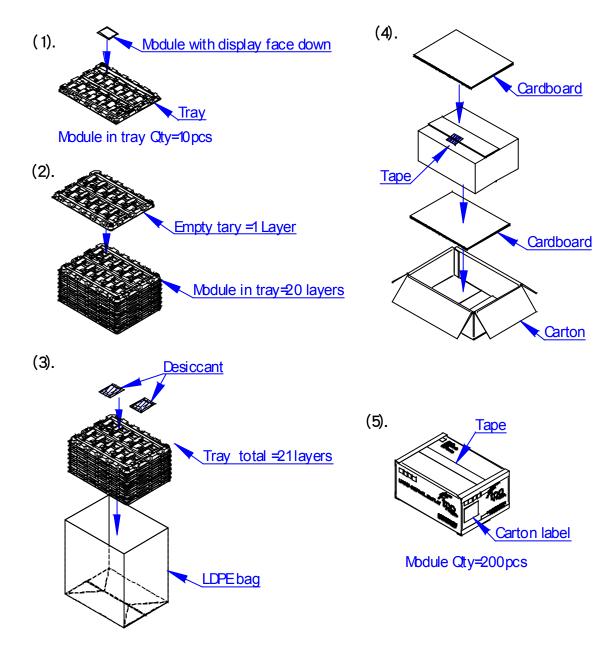


17. MECHANICAL DRAWING





18. PACKING DRAWING



- 1.9" module (TD019THEC1) delivery packing method
- (1). Module packed into tray cavity (with Module display face down).
- (2). Tray stacking with 20 layers and with 1 empty tray above the stacking tray unit. 2pcs desiccant put above the empty tray
- (3). Stacking tray unit put into the LDPE bag and fix by adhesive tape.
- (4). Put 1pc cardboard inside the carton bottom, and then pack the package unit into the carton. Put 1pc cardboard above the package unit.
- (5). Carton tapping with adhesive tape.